

2SK2014

Silicon N-Channel Power F-MOS

■ Features

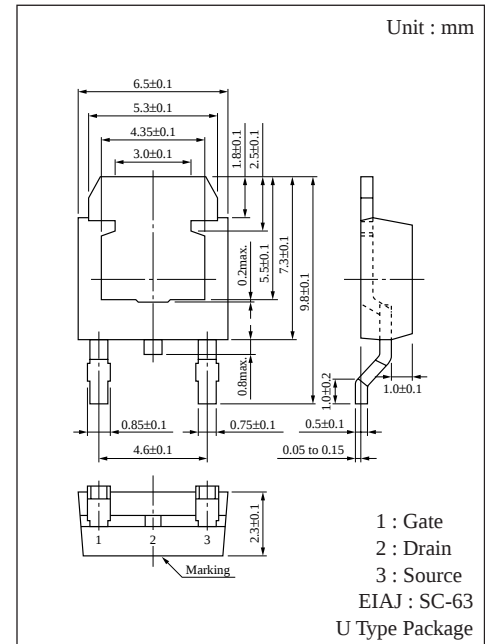
- Low ON-resistance $R_{DS(on)}$: $R_{DS(on)1} = 0.7\Omega$ (typ)
- No secondary breakdown
- Low-voltage drive possible ($V_{GS} = 4V$)
- Taping supply possible

■ Applications

- DC-DC converter
- Non-contact relay
- Solenoid drive
- Motor drive

■ Absolute Maximum Ratings ($T_c = 25^\circ C$)

Parameter	Symbol	Rating	Unit
Drain-Source breakdown voltage	V_{DSS}	100	V
Gate-Source voltage	V_{GSS}	± 20	V
Drain current	at 4V drive	I_D	± 1 A
	Pulse	I_{DP}	± 2 A
Allowable power dissipation	$T_c = 25^\circ C$	P_D	10 W
	$T_a = 25^\circ C$		0.75 W
Channel temperature	T_{ch}	150	$^\circ C$
Storage temperature	T_{stg}	-55 to +150	$^\circ C$



■ Electrical Characteristics ($T_c = 25^\circ C$)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source cut-off current	I_{DSS}	$V_{DS} = 80V, V_{GS} = 0$			10	μA
Gate-Source leakage current	I_{GSS}	$V_{GS} = \pm 15V, V_{DS} = 0$			± 10	μA
Drain-Source breakdown voltage	V_{DSS}	$I_D = 0.1mA, V_{GS} = 0$	100			V
Gate threshold voltage	V_{th}	$V_{DS} = 5V, I_D = 1mA$	0.8			V
Drain-Source ON-resistance	$R_{DS(on)1}$	$V_{GS} = 4V, I_D = 0.5A$		0.7	2	Ω
	$R_{DS(on)2}$	$V_{GS} = 10V, I_D = 0.5A$		0.62	1	Ω
Forward transadmittance	$ Y_{fs} $	$V_{DS} = 10V, I_D = 0.5A, f = 1MHz$	1		0.95	S
Input capacitance	C_{iss}	$V_{DS} = 10V, V_{GS} = 0, f = 1MHz$		188		pF
Output capacitance	C_{oss}			63		pF
Feedback capacitance	C_{rss}			14		pF
Turn-on time	t_{on}	$V_{GS} = 10V, I_D = 0.5A$ $V_{DD} = 10V, R_L = 20\Omega$		38		ns
Fall time	t_f			330		ns
Turn-off time (delay time)	$t_d(off)$			90		ns